

Features:

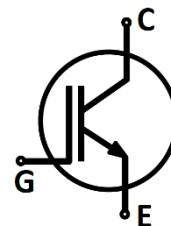
- 1200V Trench & field stop technology
- Low switching losses
- High short circuit capability
- Positive Temperature coefficient
- Easy paralleling

Recommended for:

Low / medium power modules

Applications:

Low / medium power drives



Mechanical parameters

Die size	L x W	15.9×11.7	mm ²
Emitter pad size	L x W	See chip drawing	mm ²
Gate pad size	L x W	1.31×0.811	mm ²
Silicon thickness		125	μm
Wafer size		200	mm
Maximum possible chips per wafer		132	
Passivation frontside		Polyimide	
Pad Metallization	AlCu	4	μm
Backside Metallization	Al / Ti / Ni / Ag	1.7	μm

Maximum Ratings

Parameters	Symbol	Value	Unit
Collector-emitter voltage	V_{CE}	1200	V
DC collector current, limited by $T_{vj\ max}$	I_C	200 ¹	A
Pulsed collector current, t_p limited by $T_{vj\ max}$ ²	$I_{C\ puls}$	600	A
Gate-emitter voltage	V_{GE}	± 20	V
Operating junction temperature	$T_{vj\ op}$	-40~175	°C
Storage temperature	T_{stg}	-40~150	°C
Short circuit data ³ ($V_{GE}=15V$, $V_{CC}=600V$, $T_{vj}=150^{\circ}C$)	t_{sc}	10	μs

Static Characteristic ($T_j=25^{\circ}C$, unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{GE}=15V$, $I_C=25A$	0.8	1.1	1.3	V
Gate-emitter threshold voltage	$V_{GE(th)}$	$I_C=7.4mA$, $V_{CE}=V_{GE}$	5.1	5.8	6.3	V
Collector-emitter leakage	I_{CES}	$V_{CE}=1200V$, $V_{GE}=0V$	-	-	50	μA
Gate-emitter leakage	I_{GES}	$V_{CE}=0V$, $V_{GE}=20V$	-	-	120	nA
Integrated gate resistor	R_{Gint}			2.0		Ω

¹ Depending on thermal properties of assembly.

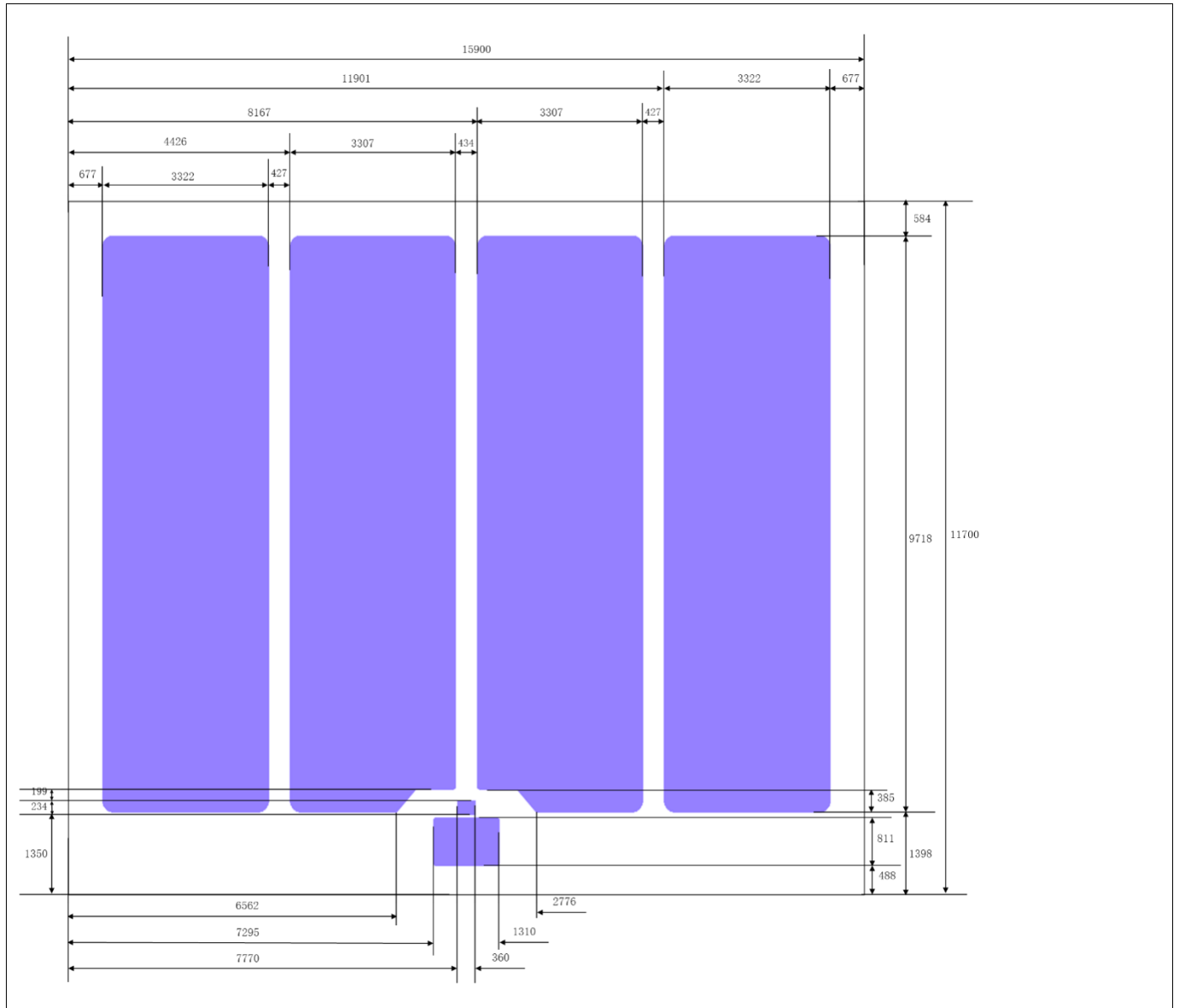
² Not subject to production test - verified by design/characterization.

³ Allowed number of short circuit: <1000; time between short circuit: >1s.

Electrical Characteristic ¹

Parameter		Symbol	Conditions	Min.	Typ.	Max.	Unit
Collector-emitter saturation voltage	$T_{vj}=25^{\circ}\text{C}$	$V_{CE(sat)}$	$V_{GE}=15\text{V}$ $I_C=200\text{A}$	1.45	1.70	2.10	V
	$T_{vj}=150^{\circ}\text{C}$			1.65	1.95	2.35	V
Input capacitance		C_{ies}	$V_{CE}=25\text{V}$ $V_{GE}=0\text{V}$, $f=100\text{kHz}$	-	24000	-	pF
Reverse transfer capacitance		C_{res}	$T_{vj}=25^{\circ}\text{C}$	-	220	-	pF

Chip Drawing (unit: μm)



¹ Not subject to production test-verified by design/characterization.

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